



Inventor: **Vishnu K. Agarwal, et al.**

Title: **Capacitor Constructions With Enhanced Surface Area**

Assignee: **Micron Technology, Inc.**

Serial No.: **10/050,334**

Filed: **January 15, 2002 [RCE filed herewith]**

Our Ref.: **MI22-1913**

**INFORMATION DISCLOSURE STATEMENT**

**PURSUANT TO 37 C.F.R. §§ 1.56, 1.97 AND 1.98**

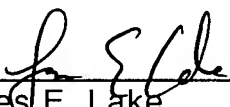
The attached Form PTO-1449 is submitted in compliance with 37 CFR §1.56. Pursuant to FEDERAL REGISTER, Vol. 69, No. 182, pg. 56542 (September 21, 2004), no copies of any cited U.S. patents or U.S. published applications are included herewith. Copies of all other cited art are attached. No admission is made regarding whether the listed references are prior art.

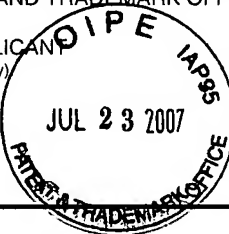
Citation of these references is respectfully requested.

Respectfully submitted,

Dated: 20 Jul 2007

By: \_\_\_\_\_

  
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Form PTO-1449		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY. DOCKET NO. MI22-1913	SERIAL NO. 10/050,334
LIST OF ART CITED BY APPLICANT (Use several sheets if necessary) <div style="text-align: center; margin-top: 10px;">  </div>				APPLICANT: Vishnu K. Agarwal	
				FILING DATE January 15, 2002	GROUP 2813

U.S. PATENT DOCUMENTS							
*Examiner's Initials		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
	AA	5,187,637	02/93	Embree			
	AB	5,444,013	08/95	Akram, et al.			
	AC	5,899,725	05/99	Harshfield			
	AD	5,905,280	05/99	Liu, et al			
	AE	5,972,769	10/99	Tsu, et al.			
	AF	6,262,469	07/01	Le et al.			
	AG	6,291,850	09/01	Choi et al.			
	AH	6,363,691	04/02	Flaherty			
	AI						

FOREIGN PATENT DOCUMENTS								
		Document Number	Date	Country	Class	Subclass	Translation	
							Yes	No
	AJ							
	AK							
	AL							

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)			
	AM		
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